Amendments to the Specification:

Please replace the replacement paragraph which bridges pages 2 and 3 as it appears in the Preliminary Amendment dated December 6, 2005 with the following amended paragraph:

The end of each of the respective striplines ML1, ML2 ~~each end~~ extends underneath a shielding SC, which is used to prevent unwanted radiation of electromagnetic waves to the surrounding area. Rear-face metallization RM, which has an aperture DB in the area of the shielding cap, is located on the lower face of the substrate S. A metallic baseplate TP is arranged on the lower face of the substrate and likewise has an aperture DB in the area of the shielding cap, so that the two apertures in the rear-face metallization of the substrate and in the baseplate TP are aligned with one another. The waveguide filter HF is screwed to this baseplate TP, with each of the openings in the waveguide filter being connected to the apertures DB.

Please amend the second full paragraph on page 3 of the clean version of the substitute specification with the following paragraph:

One disadvantage of the integration of a conventional waveguide filter in a stripline environment (for example on printed circuits) is the resultant high costs, ~~associated with this~~ which, until now, have prevented widespread use of this principle. The cost drivers in this area are the large number of

manufacturing steps and components, and the necessity to fit components on the front face and rear face of the substrate.

Page 7, amend the heading at the top of the page as follows:

DETAILED DESCRIPTION OF THE ~~DRAWINGS~~ PREFERRED EMBODIMENTS

Please amend the second full paragraph on page 7 of the clean version of the substitute specification with the following paragraph:

Manufacturing methods such as milling or plastic injection molding can be used to produce mechanically high-precision structures SK (Figures 2 and 3), so that the waveguide filter also, in a corresponding manner, has only minor electrical tolerances for the input and filter function.

Please amend the forth full paragraph on page 8 of the clean version of the substitute specification with the following paragraph:

The striplines ML1, ML2 which are formed on the upper face of the substrate S lead from the outside into the internal area of the waveguide filter HF. The metallization TM on the upper face of the substrate S forms the fourth wall, according to the invention, of the waveguide filter HF. The other side walls

of the waveguide filter HF are formed by the filter upper part FB. The metallized rear-face RM is also shown in Fig. 5.